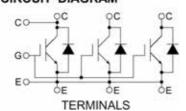
MBN1200E25C

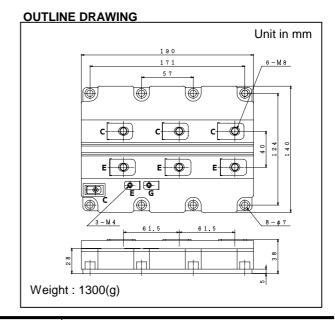
Silicon N-channel IGBT

FEATURES

- * High thermal fatigue durability. (delta Tc=70 , N>30,000cycles)
- * Low noise due to ultra soft fast recovery diode.
- * High speed, low loss IGBT module.
- * Low driving power due to low input capacitance MOS gate.
- * High reliability, high durability module.
- * Isolated head sink (terminal to base). CIRCUIT DIAGRAM



ABSOLUTE MAXIMUM RATINGS (Tc=25°C)



Item		Symbol	Unit	MBN1200E25C	
Collector Emitter Voltage		V_{CES}	V	2,500	
Gate Emitter Voltage		V_{GES}	V	±20	
Collector Current	DC	Ic	۸	1,200	
Collector Current	1ms	I _{Cp}	Α	2,400	
Forward Current	DC	I _F	۸	1,200	
Forward Current	1ms	I _{FM}	А	2,400	
Junction Temperature	T _i	°C	-40 ~ +125		
Storage Temperature	T _{stq}	°C	-40 ~ +125		
Isolation Voltage		V _{ISO}	V_{RMS}	4,000(AC 1 minute)	
Screw Torque	Terminals (M4/M8)	-	N∙m	2/10 (1)	
	Mounting (M6)	-		6 (2)	

Notes: (1) Recommended Value 1.8±0.2/9±1N·m

(2) Recommended Value 5.5±0.5N·m

ELECTRICAL CHARACTERISTICS (Tc=25°C)

Item		Symbol	Unit	Min.	Тур.	Max.	Test Conditions
Collector Emitter Cut-Off Current		I _{CES}	mA	-	-	12	V _{CE} =2,500V, V _{GE} =0V, Tj=25°C
				-	20	60	V _{CE} =2,500V, V _{GE} =0V, Tj=125°C
Gate Emitter Leakage Current		I _{GES}	nA	-500	-	+500	$V_{GE}=\pm 20V$, $V_{CE}=0V$, $Tj=25$ °C
Collector Emitter Saturation Voltage		V _{CE(sat)}	V	-	3.0	3.5	I _C =1,200A, V _{GE} =15V, Tj=125°C
Gate Emitter Threshold Voltage		$V_{GE(TO)}$	V	4.0	5.0	6.0	V _{CE} =15V, I _C =120mA, Tj=25°C
Input Capacitance		Cies	nF	ı	175	-	V _{CE} =10V, V _{GE} =0V, f=100kHz, Tj=25°C
Internal Gate Resistance		Rge		1	2.2	-	V _{CE} =10V, V _{GE} =0V, f=100kHz, Tj=25°C
Switching Times	Rise Time	t _r	μs	ı	3.2	4.4	V _{CC} =1,000V, Ic=1,200A
	Turn On Time	t _{on}		ı	4.2	5.2	L=100nH
	Fall Time	t _f		-	1.9	3.4	$R_G(ON/OFF) = 6.8/1.5$ (3)
	Turn Off Time	t _{off}			3.4	5.6	V _{GE} =±15V, Tj=125°C
Peak Forward Voltage Drop		V_{FM}	V	-	2.0	2.5	Ic=1,200A, V _{GE} =0V, Tj=125°C
Reverse Recovery Time		t _{rr}	μs	-	0.9	1.4	Vcc=1,000V, lc=1,200A, L=100nH Tj=125°C
Turn On Loss		E _{on(10%)}	J/P	-	1.8	2.3	V _{CC} =1,000V, Ic=1,200A, L=100nH
Turn Off Loss		E _{off(10%)}	J/P	-	1.2		$R_G(ON/OFF) = 6.8/1.5$ (3)
Reverse Recovery Loss		E _{rr(10%)}	J/P	-	0.35	0.85	V _{GE} =±15V, Tj=125°C
Stray inductance module		Lsce	nΗ	1	12	-	
Thermal Impedance	IGBT	Rth(j-c)	°C/W	·	-	0.0085	Junction to case
	FWD	Rth(j-c)		-	-	0.017	
Contact Thermal Impedance		Rth(c-f)	°C/W	-	0.006	-	Case to fin

Notes:(3) R_G value is the test condition's value for evaluation of the switching times, not recommended value. Please, determine the suitable R_G value after the measurement of switching waveforms (overshoot voltage, etc.) with appliance mounted. Counter arm IGBT V_{GE} =-15V

HITACHI POWER SEMICONDUCTORS

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